# LAPSE OF CONVERTIBLE BOND AGREEMENT WITH JINZHOU BUSINESS INVESTMENT LOGISTICS CO., LTD (锦州商投物流有限公司)

#### 1. INTRODUCTION

Unless otherwise defined, all terms and references used in this announcement shall bear the same meaning ascribed to them in the Company's announcements dated 5 February 2020, 27 March 2020, 2 April 2020, 29 May 2020, and 30 July 2020 (the "**Previous Announcements**") in relation to, *inter alia*, the signing of the Convertible Bonds Agreements, first extension of Cut-Off Date in respect of the Convertible Bond Agreement with JBIL ("**First Variation Letter**"), the receipt of the listing and quotation notice for the Series A Bonds, second extension of Cut-Off Date in respect of the Convertible Bond Agreement with JBIL ("**Second Variation Letter**"), and third extension of Cut-Off Date in respect of the Convertible Bond Agreement with JBIL ("**Third Variation Letter**").

Pursuant to the Convertible Bond Agreement ("JBIL Agreement") entered into between the Company and Jinzhou Business Investment Logistics Co., Ltd (锦州商投物流有限公司) ("JBIL") on 30 January 2020, JBIL had agreed to subscribe for an initial tranche of Bonds (i.e. the Series A Bonds) of a principal amount equivalent to S\$3,000,000 ("Series A Subscription"), subject to the satisfaction of certain conditions precedent as set out in paragraph 4.3.1 of the Company's announcement dated 5 February 2020 ("General Conditions Precedent").

Pursuant to the terms of the JBIL Agreement and the Third Variation Letter, the last date for the satisfaction of the General Conditions Precedent is 30 September 2020 ("**Third Extension of Cut-Off Date**").

## 2. LAPSE OF THE JBIL AGREEMENT

Further to the Previous Announcements, the Board wishes to announce that the JBIL Agreement has lapsed as the General Conditions Precedents had not been satisfied by the Third Extension of Cut-Off Date (the "Lapse of JBIL Agreement"). The Company and JBIL (each the "Party" and collectively the "Parties") have mutually agreed not to further extend the Cut-Off Date as set out in the Third Variation Letter.

Following the Lapse of JBIL Agreement, the Parties shall be released and discharged from their respective obligations under the JBIL Agreement save and except for certain surviving clauses. The Company is not expected to incur material costs arising from the Lapse of JBIL Agreement.

The Lapse of JBIL Agreement is not expected to have any material impact on the consolidated net tangible assets and earnings per share of the Group for the current financial year ending 31 December 2020.

The Company will continue to explore other alternative modes of capital fund-raising, which includes seeking Shareholders' approval for the subscription of Series B Bonds by Atrium Asia and Kingpin with an aggregate principal amount of up to S\$8,000,000 in forthcoming general meeting(s). As set out in the Company's announcement dated 14 August 2020 for the unaudited financial statements for the period ended 30 June 2020, an aggregate of S\$2,000,000 was received from the completion of the Series A Bonds issuance to Kingpin and Atrium Asia.

The Company will keep Shareholders updated of developments as and where appropriate.

## 3. CAUTIONARY STATEMENT

Shareholders are advised to read this announcement and any further announcements by the Company carefully. In the event of any doubt, Shareholders should consult their stockbrokers, bank managers, solicitors, accountants or other professional advisors.

#### By Order of the Board

Soh Sai Kiang Independent Non-Executive Chairman 30 September 2020

This announcement has been reviewed by the Company's sponsor, SAC Capital Private Limited (the "Sponsor"). This announcement has not been examined or approved by the Singapore Exchange Securities Trading Limited ("SGX-ST") and the SGX-ST assumes no responsibility for the contents of this announcement including the correctness of any of the statements or opinions made or reports contained in this announcement.

The contact person for the Sponsor is Mr David Yeong (Telephone number: +65 6232 3210), at 1 Robinson Road, #21-00 AIA Tower, Singapore 048542.